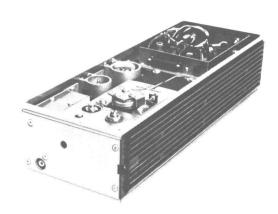


MASTR PROGRESS LINE

150.8-174 MHz,80-WATT TRANSMITTER MODEL 4ET58J10, J11, & J12 (Options 7520 thru 7525)



SPECIFICATIONS *

FCC Filing Designation:

Model Numbers: 4ET58J10 4ET58J11 4ET58J12

Maximum Frequency Spread Between Sub-Bands:

Minimum Frequency Spread Between Sub-Bands:

Maximum Frequency Spread Within Sub-Bands:

Power Output:

Crystal Multiplication Factor:

Frequency Stability:

Spurious & Harmonic Radiation:

Modulation:

Audio Frequency Characteristics:

Distortion:

Deviation Symmetry:

Tubes & Transistors:

Duty Cycle:

ET-58-J

2 Frequencies

3 Frequencies

4 Frequencies

10.0 MHz

500 kHz

500 kHz

80 Watts minimum

12

 $\pm .0005\%$ (-30°C to +60°C)

At least 85 dB below rated power output

Adjustable from 0 to $\pm 5~\mathrm{kHz}$ swing with instantaneous modulation limiting

Within +1 dB to -3 dB of a 6 dB/octave pre-emphasis from 300 to 3000 Hz per EIA standards. Post limiter filter per FCC and EIA

Less than 5%

0.5 kHz maximum

3 tubes 23 transistors 19 diodes

20% transmit (one minute transmit, four minutes off)

*These specifications are intended primarily for the use of the serviceman. Refer to the appropriate Specification Sheet for the complete specifications.

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-WARNING-

No one should be permitted to handle any portion of the equipment that is supplied with high voltage; or to connect any external apparatus to the units while the units are supplied with power. KEEP AWAY FROM LIVE CIRCUITS.

DESCRIPTION

MASTR Progress Line FM transmitter Model 4ET58J10, 11 and 12 are crystal controlled, phase-modulated transmitters designed for four-frequency operation on two sub-bands in the 150.8 to 175 MHz range. The transmitter consists of the following modules:

- Exciter Board A108/A110/A112: transistorized audio, oscillator, modulator, amplifier and multiplier stages.
- Exciter Board Al35/Al36: transistorized audio, oscillator, modulator, amplifier, multiplier and solenoid control stages.
- Tubed multiplier and power amplifier stages.

The application of each of the transmitter options is shown in the following chart:

Option Number	Model Number	Number of Frequencies	Channel Guard
7520	4ET58J10	Two	No
7521	4ET58J11	Three	No
7522	4ET58J12	Four	No
7523	4ET58J10	Two	Yes
7524	4ET58J11	Three	Yes
7525	4ET58J12	Four	Yes

All input leads to the transmitter are individually filtered by the 20-pin feed-through by-pass connector J101. The output passes through a four-section, low-pass filter that features good shielding between sections, and Teflon® capacitors for filfree operation with an open or shorted antenna.

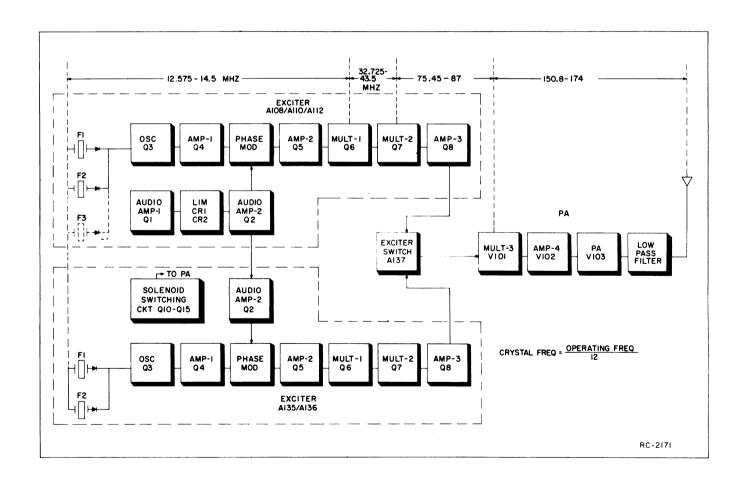


Figure 1 - Transmitter Block Diagram

CIRCUIT ANALYSIS

The frequency of the crystals used ranges from 12.575 to 14.5 megahertz, and the crystal frequency is multiplied twelve times.

A centralized meter jack (J102) is provided for use with General Electric Test Set 4EX3A10. The Test Set meters the multiplier, amplifier and PA stages as well as filament and regulated supply voltages. The metering jack also provides access to receiver audio, microphone and push-to-talk leads.

POWER INPUTS

The following supply voltages are connected from the power supply to the transmitter through the 20-pin by-pass connector .1101:

- Pin 3 -- Filament voltage
- Pin 4 -- +300 volts MULT B+
- Pin 5 -- +680 volts PA B+
- Pin 8 -- 45 volts bias
- Pin 15 -- 20 volts for Exciter Board

EXCITER BOARDS

The transmitter uses Exciter Boards A108.A110/A112 and A135/A136 for operation on two sub-band frequencies spaced up to 10.0 MHz apart. The exciter boards can be connected for operation in either of the sub-band frequency ranges. The sub-bands can be moved from one exciter board to the other by changing connections to J22 through J27 on Exciter A135/A136. Instructions for setting up the sub-band frequencies are contained on the Sub-Band Connection Chart as listed in the Table of Contents.

Both Exciter Boards contain identical oscillator, amplifier and multiplier circuits (Q2 through Q8). Exciter Allo contains an audio amplifier and limiter circuit (Q1, CR1 and CR2), and Exciter Al36 contains the PA solenoid switching circuit (Q10 through Q15).

OSCILLATORS

Each exciter board contains identical transistorized Colpitts oscillators. The oscillator crystals are thermistor-compensated at both ends of the temperature range to provide instant frequency compensation, with a frequency stability of $\pm 0.0005\%$ without crystal ovens or warmers.

The proper crystal frequency is selected by switching the crystal keying lead to ground by means of a frequency selector switch on the control unit. This forward biases the selected switching diode (CR3 thru CR5), reducing its impedance. This permits the crystal frequency to be applied to the base of oscillator Q3. Feedback for the oscillator is developed across C34. The oscillator output is coupled through an impedance matching emitter-follower amplifier stage (Q4) to the phase modulator.

AUDIO AMPLIFIERS AND LIMITER (A108/A110/A112)

An audio signal from the microphone is coupled through C1 to the base of Class A audio amplifier Q1. The design of the microphone, in conjunction with C2 and R3, produces a 6-dB audio pre-emphasis. RF decoupling is provided by R10 and C75.

The amplified audio signal is RC coupled to the diode limiters, CR1 and CR2. These diodes operate in series and are normally in a forward conducting state. An audio signal of sufficient amplitude to cause limiting takes the diodes out of conduction, so that one diode conducts only on positive cycles and the other conducts only on negative cycles.

Following the limiter stage is a second Class A amplifier, Q2. The collector output of Q2 is coupled through MOD ADJUST potentiometer R12 to a combined post-limiter filter and de-emphasis network. This network consists of R15, R16, R17, C4, C7 and C8/C9. The output of the filter and de-emphasis network is applied directly to the phase modulator.

AUDIO AMPLIFIER (A135/A136)

Audio from the emitter of Allo-Q2 is coupled through C82 to the base of audio amplifier Al36-Q2. The output of Q2 is coupled through MOD ADJUST potentiometer Rl2 to a combined post-limiter filter and demphasis network. This network consists of Rl5, Rl6, Rl7, C7 and C8/C9. The output of the filter and de-emphasis network is applied directly to the phase modulator.

PHASE MODULATORS (A108 & A135)

The phase modulator uses varactor CVI (voltage variable capacitor) in series with tuneable coil L1. This network appears as a series-resonant circuit to the RF output of the oscillator. An audio signal applied to the modulator varies the bias of CVI, resulting in a phase-modulated output. The output of the modulator is coupled through blocking capacitor C45 to the base of the second amplifier.

A second modulator stage is cascaded with the first modulator to permit the use of 6-Tone Channel Guard Encoder Model 4EH15A10. The output of the Channel Guard encoder is fed through CHANNEL GUARD MOD ADJUST R34 to the modulator stages. The voice audio is also applied to both modulator stages.

AMPLIFIERS, 1st & 2nd MULTIPLIERS (A108 & A135)

The second amplifier (Q5) isolates the modulator from the loading effects of the first multiplier and provides amplification. The output is DC coupled to the first multiplier.

Following Q5 are two inductively coupled Class C, common-emitter multiplier stages (Q6 and Q7). Q6 is a tripler, with collector tank T1 tuned to three times the crystal frequency. Metering resistor R50 is for metering the MULT-1 stage at centralized metering jack J102.

Q7 operates as a doubler stage, with collector tank T3 tuned to six times the crystal frequency. Resistor R79 is for metering the MULT-2 stage at J102. The output of Q7 is inductively coupled through T3 and T4 to amplifier Q8. Capacitor C58 provides some high-side capacitive coupling.

Third amplifier Q8 is a neutralized straight-through amplifier. Feedback through C65 from the output link on T5 pro-

vides neutralization. This stage is metered at J102-3 across R48.

SOLENOID CONTROL CIRCUIT (A135/A136)

The solenoid control circuit energizes or de-energizes the PA plate solenoid to shift the PA plate resonance from one sub-band to the other. The solenoid is energized when operating on the high sub-band frequency and de-energized when operating on the low sub-band frequency.

The circuit consists of LATCH gate Q14, UNLATCH gate Q13, flip-flop Q10 & Q11, DC switch Q12, and current cut-back stage Q15 and R110 (located on A137). A simplified Control Circuit diagram is shown in Figure 2.

With a high sub-band frequency selected at the control unit, keying the transmitter forward biases one of the LATCH gate diodes, turning on Q14. This turns off Q11 in the flip-flop, which turns on Q10. Turning on Q10 also turns on DC Switch Q12 and current cutback transistor Q15. Turning on Q12 and Q15 short circuits currentlimiting resistor R110 so that the full supply voltage is used to energize the solenoid. Turning on Q15 also discharges capacitor C81. When the capacitor charges, Q15 turns off, removing the short across current-limiting resistor R110. The solenoid is now kept energized at a reduced current drain through R110 and Q12.

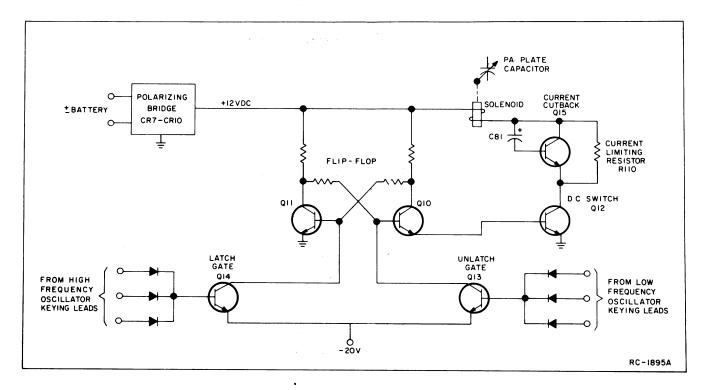


Figure 2 - Solenoid Control Circuit

Q10 and Q12 will remain on (keeping the solenoid energized) until the transmitter is operated on one of the high sub-band frequencies.

With a high sub-band frequency selected at the control unit, keying the transmitter forward biases one of the diodes in the UNLATCH gate, turning on Q14. This turns off Q10 in the flip-flop, which turns off DC switch Q12, de-energizing the solenoid.

Q10 will remain off (with Q11 on) until the transmitter is operated on one of the low sub-band frequencies.

EXCITER SWITCH (A137)

The RF developed at the output of the exciter operates the corresponding transistor switch (Q1 or Q2) on the Exciter Switch Al37, coupling the RF to transformer T101 in the grid circuit of multiplier V101.

PA ASSEMBLY

The PA assembly includes the tubed multiplier, amplifier and power amplifier stages. Interstage coupling is provided by three pairs of inductively-coupled, stagger-tuned circuits with one circuit in each pair tuned to the high frequency subband and the other tuned to the low frequency sub-band.

The PA plate circuit is tuned by a silver-plated copper slug and the solenoid-operated capacitor. The solenoid is energized to provide the additional capacitance required for shifting the plate tank resonance from the high sub-band frequency to the low sub-band frequency.

3RD MULTIPLIER

The output of the selected exciter is coupled by the transistor switch on Al37 to RF transformer Tl01. The primary (L2) and secondary (L1) of transformer Tl01 are variable for tuning the grid of Vl01. This stage operates as a doubler with the plate tank tuned to twelve times the crystal frequency. The plate tank is tuned by Cl10.

The grid of V101 is metered through metering resistor R102 at J102-4. R101 drops the bias voltage to approximately -18 volts to protect V101 against loss of drive. Plate voltage is supplied through L101.

When measuring grid current to V101, there will be a residual reading of approximately 0.18 volts without any drive. This is caused by the presence of fixed bias voltage on the grid of the tube.

POWER AMPLIFIER

Drive from 4th amplifier V102 is inductively coupled to the grid of power amplifier V103 through L106 and L108.

The PA grid is metered at J102-6 through metering resistor R115. Bias voltage is applied to the control grids through R116.

Power amplifier V103 is a dual tetrode operating in a push-pull circuit. The PA plate is tuned by L112, and by solenoid-operated capacitor C136. High B-plus is supplied through L110 to a center tap on the plate tank coil L112. C122 is a high-voltage by-pass capacitor. The screen grid dropping resistors are R117 and R118. Plate current is metered from J102-1 to J102-9 across metering resistor R120.

– WARNING —

The meter leads are at plate potential (high B-plus) when metering the PA plate,

Placing the TUNE-OPERATE switch (S102) in the OPERATE position applies 300 volts to TB3-7 and TB3-5. The 300 volts appearing on each side of R117 effectively shorts the resistor out of the circuit, and the screen voltage is applied through R118 for normal operation of V103. With S102 in the TUNE position, the screen voltage is applied to TB3-5 only. Now, dropping resistors R117 and R118 are in series, to reduce the screen voltage. This reduces the plate dissipation of V103 while tuning the power amplifier stage.

Antenna coupling is achieved by varying the coupling betweel L112 and L114. C123 tunes the antenna circuit.

The RF output from the antenna coil is fed to low-pass filter FL101. This filter has a low insertion loss and a harmonic attenuation of at least -50 dB through all harmonics. The filter output is fed to the antenna changeover relay located on the front of the system frame.

ANTENNA CUTTING INSTRUCTIONS

The following antenna cutting procedure provides a whip length that is a compromise between two (or more) different ideal lengths for the widely spaced operation frequencies.

The compromise length is also affected by the location of the antenna on the vehicle and by the length of the transmission line between the antenna and the transmitter. It should be noted that if the position of the antenna or the length of the transmission line is changed, it will probably be necessary to cut a new whip to accommodate the new conditions.

- 1. Install antenna model 4EY12A13 according to instructions except for Step 11. Do not cut the whip, but install it full length (approximately 19-1/2" long).
- Connect a transmitter which has been tuned and loaded into an absorption wattmeter (such as a Bird Termiline) to the antenna.
- 3. With the transmitter operating on the lowest frequency in the low frequency sub-band, adjust the ANT COUPLING and the ANT TUNING controls for 0.7 V "G" reading on the GE Test Set according to the Transmitter Alignment Procedure (see Table of Contents).
- 4. Switch to the highest frequency in the high frequency sub-band and observe the "G" reading. The reading will be less than the 0.7 V reading obtained in Step 3 above.
- Cut approximately 1/4" off of the whip and repeat Steps 3 and 4.
- 6. Continue this procedure, with progressively smaller increments of cutting until the "G" reading observed in step 4 is 0.7 V, duplicating the reading obtained by adjustment in Step 3.

CHANNEL GUARD ENCODER

Channel Guard Encoder Model 4EH15A10 is an externally mounted, fully transist-orized encoder utilizing tone networks for added stability and reliability. The encoder is designed to modulate MASTR transmitters with up to six Channel Guard tones. The tone frequencies range from 71.9 to 203.5 Hz.

Refer to Maintenance Manual LBI-3660 for complete encoder instructions.

MAINTENANCE

DISASSEMBLY

To service the transmitter from the top --

- 1. Pull locking handle down and pull radio about one inch out of mounting frame.
- 2. Pry up cover at rear of transmitter.
- Slide cover back and lift off.

To service the transmitter from the bottom -

- Pull locking handle down and pull radio out of mounting frame.
- Remove the two screws in the bottom cover, and pry up at back of transmitter.
- 3. Slide cover back and lift off.

- NOTE -

The tube shields for the 80-watt transmitter are spring-loaded, and can be pulled off of the tube.

To remove transmitter from system frame --

- 1. Loosen the two retaining screws in the front casting (see Figure 3) and pull casting away from the system frame.
- 2. Remove the four screws in the back cover.
- 3. Remove the two screws holding the transmitter at each end of the system frame.
- 4. Disconnect the antenna jack in front of the transmitter and the 20-pin feed-thru connector at the back of the transmitter, and slide the unit out of the system frame.

MAINTENANCE

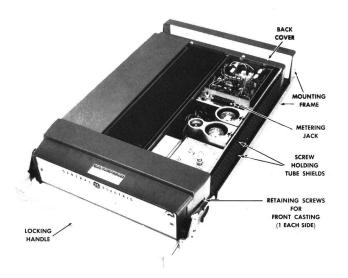




Figure 3 - Top Cover Removed

Figure 4 - Bottom Cover Removed

MODULATION LEVEL ADJUSTMENT

The MOD ADJUST (R12) was adjusted to the proper setting before shipment and should not normally require readjustment. This setting permits approximately 75% modulation for the average voice level. The audio peaks which would cause overmodulation are clipped by the modulation limiter. The limiter, in conjunction with the de-emphasis network, instantaneously limits the slope of the audio wave to the modulator, thereby preventing overmodulation while preserving intelligibility.

TEST EQUIPMENT

- 1. An audio oscillator Model 4EX6A10
- 2. A frequency modulation monitor
- 3. An output meter or a VTVM
- 4. GE Test Set Models 4EX3A10 or 4EX8K11

PROCEDURE

- 1. Connect the audio oscillator and the meter across input terminals J5 (Green-Hi) and J6 (Black-Lo) on GE Test Set, or across J1 (Mike High) and J2 (Mike Low) on the Exciter Board.
- 2. Apply a 1.0-volt signal at 1000 Hz to Test Set or across J1 and J2 on Exciter Board.
- 3. For transmitters without Channel Guard, set the MOD ADJUST (R12) on both exciter boards for a 4.5-kilohertz swing with the deviation polarity which gives the highest reading as indicated on the frequency modulation monitor.
- 4. For transmitters with Channel Guard, pre-set the Channel Guard MOD ADJUST (R34) to the mid-range position on both exciter boards. Next, set R34 on each exciter for 0.75 kHz tone deviation. Then repeak L1 and L3 as shown in Step 1 of Transmitter Alignment Procedure. Reset tone deviation to 0.75 kHz deviation. Remove the tone to the transmitter by unplugging leads to J7 and J8 on both Exciter Boards. Next, apply a 1.0 volt signal at 1000 Hz and set MOD ADJUST (R12) on each exciter for 3.75 kHz deviation on the channel producing the largest amount of deviation (4.5 kHz minus 0.75-kHz tone deviation).

PA PLATE POWER INPUT

For FCC purposes, the PA Plate power input can be determined by measuring the PA Plate voltage and the plate current indication, and using the following formula:

= Plate Voltage x Plate Current Indication 3.0

Where:

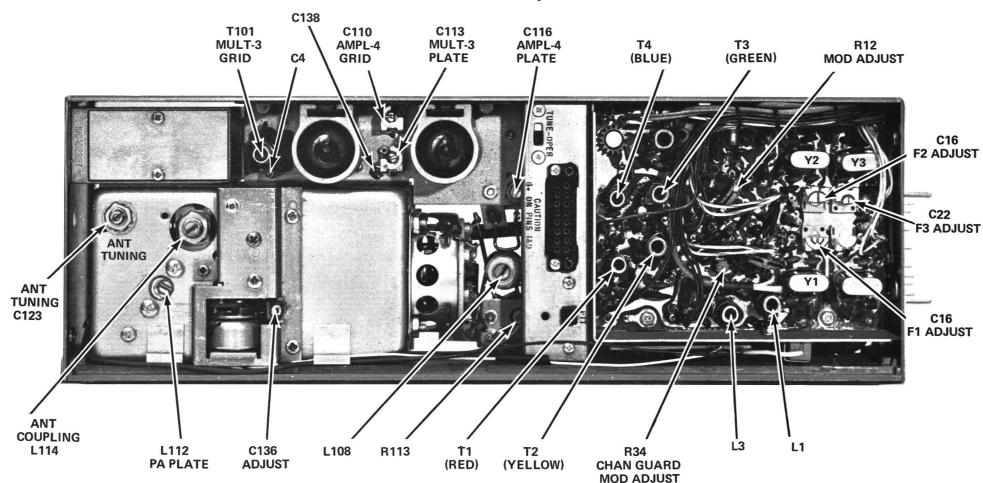
Pi is the power input in watts.

Plate voltage is measured with GE Test Set in position G, using the 1000-volt scale (or measured from J102-1 to -16 with multimeter).

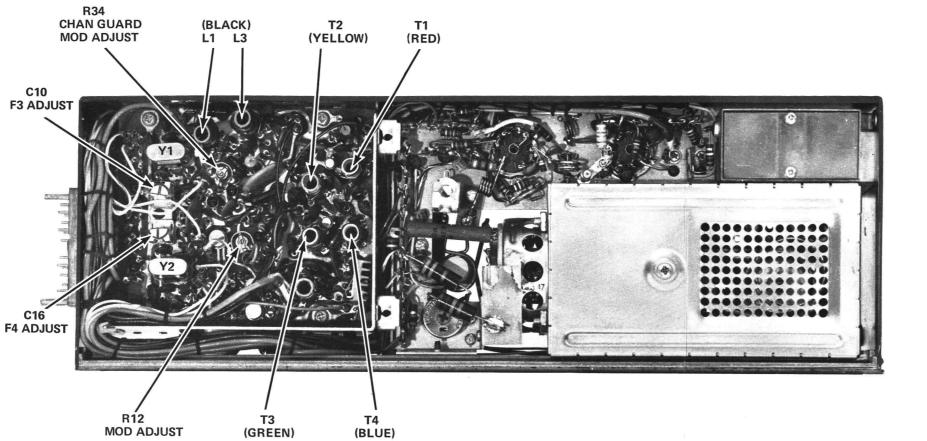
Plate current indication is measured with GE Test Set in Position G, using the TEST 1 scale (or measured from J102-1 to -9 with multimeter).

3.0 is the value of the plate current metering resistor in ohms.

EXCITER A110/A112



EXCITER A136



TRANSMITTER ALIGNMENT

EQUIPMENT REQUIRED

GE Test Set Models 4EX3A10 or 4EX8K11, Station Metering Panel, or a 20,000 ohm-per-Volt Multimeter with a 1-Volt scale.

PRELIMINARY CHECKS AND ADJUSTMENTS

- 1. Place crystals (operating frequency : 12) into crystal sockets, and place the TUNE-OPERATE switch in the TUNE position.
- 2. For a badly mis-aligned transmitter, set the crystal trimmers to mid-capacity. Set the slugs in the coils of both exciter boards to the bottom of the coil form. Then set one slug in T101 to the top of the coil form and the other slug to the bottom of the coil form.
- 3. On two-frequency exciter boards, align the transmitter on the highest frequency. On three-frequency exciter boards, align the transmitter on the center frequency.

In this procedure, the Alignment Frequency in the low frequency sub-band will be designated AF-1. The alignment frequency in the high frequency sub-band will be designated AF-2.

- 4. Connect the GE Test Set to Centralized Metering Jack J102. If using a Multimeter, connect the positive lead to J102-16 (Ground) unless otherwise indicated.
- 5. Place the frequency selector switch in the AF-1 (low frequency sub-band) position.
- 6. Place the Tune/Operate switch in the Tune position.
- 7. Set R113 to mid range.
- 8. All adjustments are made with the transmitter keyed

NOIE

Do not key the transmitter over 10 seconds in each 30-second period.

ALIGNMENT PROCEDURE

	METERING	POSITION			l i	
STEP	GE TEST SET	MULTIMETER (-) AT J102)	TUNING CONTROL	TYPICAL METER READING	PROCEDURE	
					EXCITERS	
1,	A (Mult-1)	Pin 10	L1 and L3	0.8V (0.5V Minimum)	Tuning the modulator is a critical adjustment. Alternately tune L1 and L3 for maximum meter reading.	
2.	A	Pin 10	T1	See Procedure	Tune Tl for a small change in meter reading.	
3.	B (Mu1t-2)	Pin 2	T2 and T1	0.65V (0.5V Minimum)	Alternately tune T2 and T1 for maximum meter reading.	
4.	B (Mult-2)	Pin 2	Т3	See Procedure	Tune T3 for a change in meter reading.	
5.	C (Amp1-3)	Pin 3	T4, T3, & T5	0.6V (0.5V Minimum)	Alternately tune T4 and T3 for maximum meter reading. Tune T5 for minimum meter reading.	
6.				See Procedure	Switch to AF-2 and perform Steps 1 thru 5 on the other exciter board.	
		•	·	I	PA ASSEMBLY	
7.	D (Mult-3)	Pin 4	T101 (Mult-3 Grid)	See Procedure	Adjust C4 to approximately 18 turns out from maximum capacity, turn C4 clockwise approximately 1-1/2 turns for each MHz of sub-band spread. Tune	
					the top slug to AF-1 and the bottom slug to AF-2 until both readings are maximum. If the readings are too low, increase the capacity of C4. If the readings "pull", decrease the capacity of C4. Repeat steps 5 and 7 on both exciters.	

LBI-4306

TUNING

CONTROL

MULTIMETER

(-) AT J102)

STEP

GE TEST SET

TYPICAL

METER

READING

8.	E (Ampl-4)	Pin 5	C110 and C113	0.4 Volt Minimum	Alternately tune C110 at AF-1 and C113 on AF-2 for maximum meter readings.
					NOTE
					Adjust C138 to approximately 20 turns out from maximum capacity. Turn C138 clockwise approximately 2 turns for each MHz of sub-band spread. If the readings are too low, increase the capacity of C138. If the readings "pull", decrease the capacity of C138. If the final readings are less than 0.4V or different by more than 0.08 V repeat Step 8.
9.	F (PA Grid)	Pin 14 (+) and Pin 6 (-)	L108 and C116	0.9 Minimum	Alternately tune L108 to AF-1 and C116 to AF-2 for maximum meter readings. If 0.9 Volts is not obtained, or if both readings are not within 0.1 Volt, adjust R113 to give a reading of 0.7 Volts on the frequency producing maximum.
					NOTE
					The inter-stage coupling is quite critical. If the readings differ by more than 0.15 Volts, adjust coupling between L106 and L108. Position L106 closer to L108 for greater coupling or farther away for less coupling. Repeat Step 9.
10.					Rotate ANTENNA COUPLING control fully clockwise.
11.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	L112, L114 & C136	Minimum	Adjust L112 and ANT COUPLING for minimum meter reading on AF-2. Next, adjust C136 by means of the solenoid stop screw for minimum meter reading on AF-1.
		WARNI High B+ on and 9			
12.					Place the TUNE-OPERATE switch in the OPERATE position.
13.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	L112, L114 & C136	Minimum	Tune L112 and ANT COUPLING on AF-2 and C136 on AF-1 for minimum meter reading.
14.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	Ant Coupling and ANT Tuning	See Procedure	Switch to AF-1 and adjust ANT COUPLING control for a meter reading of approximately 0.5 Volts. Next, adjust ANT TUNING control for maximum meter reading on AF-2.
15.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	Ant Coupling and ANT Tuning	0.5 V	Alternately adjust ANT COUPLING for a meter reading of 0.5 Volts and ANT TUNING for maximum meter reading, until the maximum ANT TUNING meter reading is 0.5 Volt.
16.	F (PA Grid)	Pin 14 (+) and Pin 6 (-)	L108 and C116	Maximum (1.0 V Minimum)	Alternately tune L108 on AF-1 and C116 on AF-2 for maximum meter reading. If both readings are not within 0.10 Volt, repeat Step 9. F reading must not exceed 1.0 V.
17.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	ANT TUNING and ANT COUPLING	See Procedure	Switch to AF-1. Alternately adjust ANT TUNING for maximum meter reading and ANT COUPLING for a meter reading of 0.7 Volt until the ANT TUNING meter reading is 0.7 Volt.
18.	G (PA Plate)	Pin 1 (+) and Pin 9 (-)	ANT COUPLING	0.7 V	Observe the meter reading on both AF-1 and AF-2, Adjust the ANT COUPLING control for a meter read- ing of 0.7 Volt on the alignment frequency produc- ing the highest meter reading.
				FREQU	UENCY ADJUSTMENT
19.					With no modulation applied, adjust crystal trimmers C10 and C16 (C22 when required) on both exciters

ALIGNMENT PROCEDURE

150.8—174 MHz MASTR TRANSMITTER MODELS 4ET58J10-12

PROCEDURE

TEST PROCEDURES

LBI-4306

These Test Procedures are designed to assist you in servicing a transmitter that is operating--but not properly. Problems encountered could be low power output. low B plus, tone and voice deviation, defective audio sensitivity and modulation adjust control set too high. By following the sequence of test steps starting with Step 1, the defect can be quickly

localized. Once a defect is pin-pointed, refer to the "Service Check" and the additional corrective measures included in the Transmitter Troubleshooting Procedure. Before starting with the Transmitter Test Procedures, be sure the transmitter is tuned and aligned to the proper operating frequency.

TEST EQUIPMENT REQUIRED

for test hookup as shown:

1. Wattmeter similar to: 2. VTVM similar to: 3. Audio Generator similar to:

Bird #43 Jones #711N Triplett #850 Heath #IM-21

GE Model 4EX6A10 or Heath #IG-72

4. Deviation Meter (with a .75 kHz scale) similar

Measurements #140 Lampkin #205A

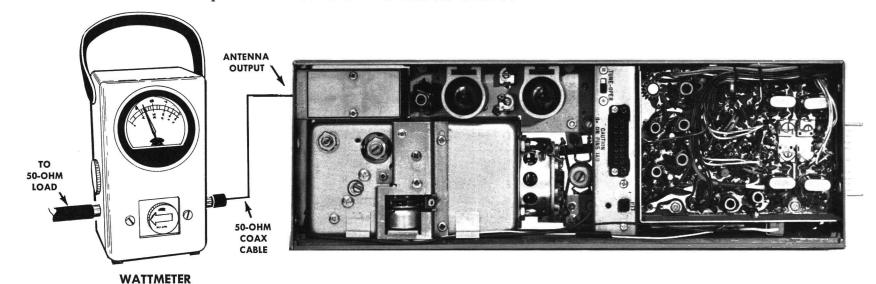
5. Multimeter similar to:

GE METERING TEST SET MODEL 4EX3A10 or Triplett #631 or 20.000 ohms-per-volt voltmeter

STEP 1

POWER MEASUREMENT TEST PROCEDURE

1. Connect transmitter output to wattmeter as shown below:



2. Key transmitter and check wattmeter for minimum reading of 80 watts.

SERVICE CHECK

Refer to Service Hints on Transmitter Troubleshooting Procedure.

STEP 2

TONE DEVIATION WITH CHANNEL GUARD TEST PROCEDURE

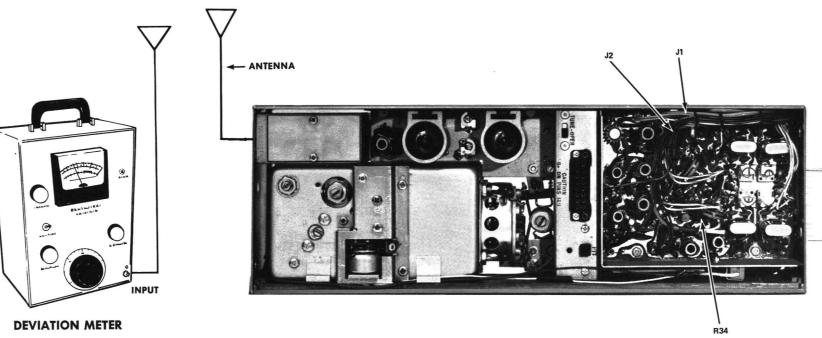
1. Setup Deviation Meter and monitor output of transmitter as shown below:

2. Unplug the MIC HI terminal from Jl on Transmitter Exciter Board.

MOD ADJUST (R34) for a reading of 0.75 kHz.

NOTES:

NOTES:



3. Key transmitter and check for 0.75 kHz deviation. If reading is low or high, adjust Channel Guard

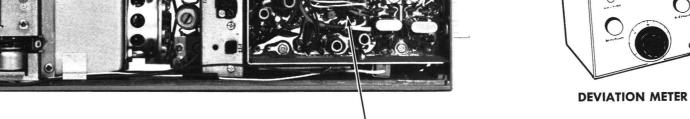
The Channel Guard MOD ADJUST (R34) may be adjusted for deviations up to 0.80 kHz for tone frequencies

1. On units supplied with Channel Guard, the Phase Modulator Tuning should be peaked carefully

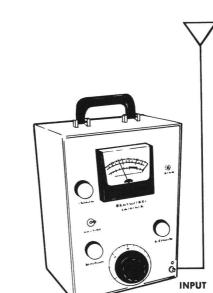
to insure proper performance. (Refer to Steps 1 and 2 in the Transmitter Alignment Chart).

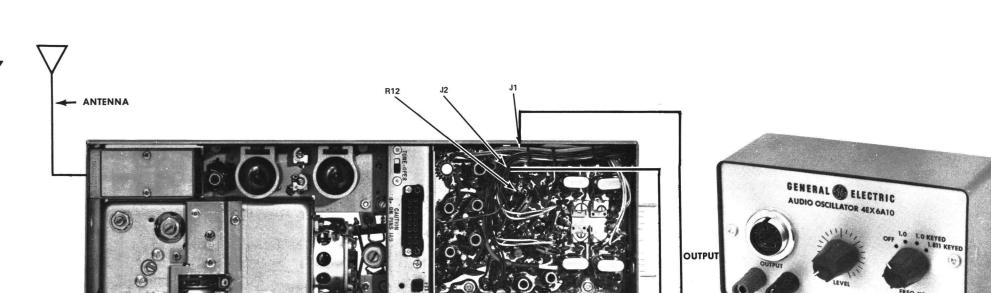
2. The tone Deviation Test Procedures should be repeated everytime the Tone Frequency is changed.

from 71.9 Hz to 82.5 Hz and deviations up to 1.0 kHz for all tone frequencies above 82.5 Hz.



DEVIATION METER





- 3. Set the generator output to 1.0 VOLTS RMS and frequency to 1 kHz
- 4. Key the transmitter and adjust Deviation Meter to carrier frequency.
- 5. Deviation reading should be ±4.5 kHz.
- DEVIATION METER 6. Adjust "Modulation Adjust Control" R12 until deviation reads 4.5 kHz on plus (+) or minur (-) deviation, whichever is greater. This adjustment should be made with the correct level of tone applied on Channel Guard transmitters. Leave the audio oscillator connected to A108/A110/A112 and adjust R12 on Exciter A135/A136 for 4.5 kHz on plus or minus deviation (whichever is greater).

NOTES: --MASTR transmitters are adjusted for 4.5 kHz deviation at the factory. The factory adjustment will prevent the transmitter from deviating more than 5.0 kHz under the worst conditions of frequency,

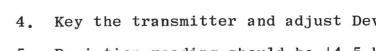
- If the deviation reading plus (+) and minus (-) differs by more than 0.5 kHz, check the following:
- 1. Recheck Step 1 as shown in the Transmitter Alignment Chart.
- 2. Check Audio Sensitivity by reducing generator output until deviation falls to 3.3 kHz. Voltage should be LESS than 90 millivolts.

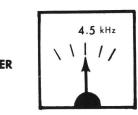
VOICE DEVIATION AND SYMMETRY TEST PROCEDURE

1. Unplug the High and Low Mike leads from Jacks J1 and J2 on Exciter Board A108/A110/A112.

STEP 3

2. Connect test equipment to transmitter as shown below:



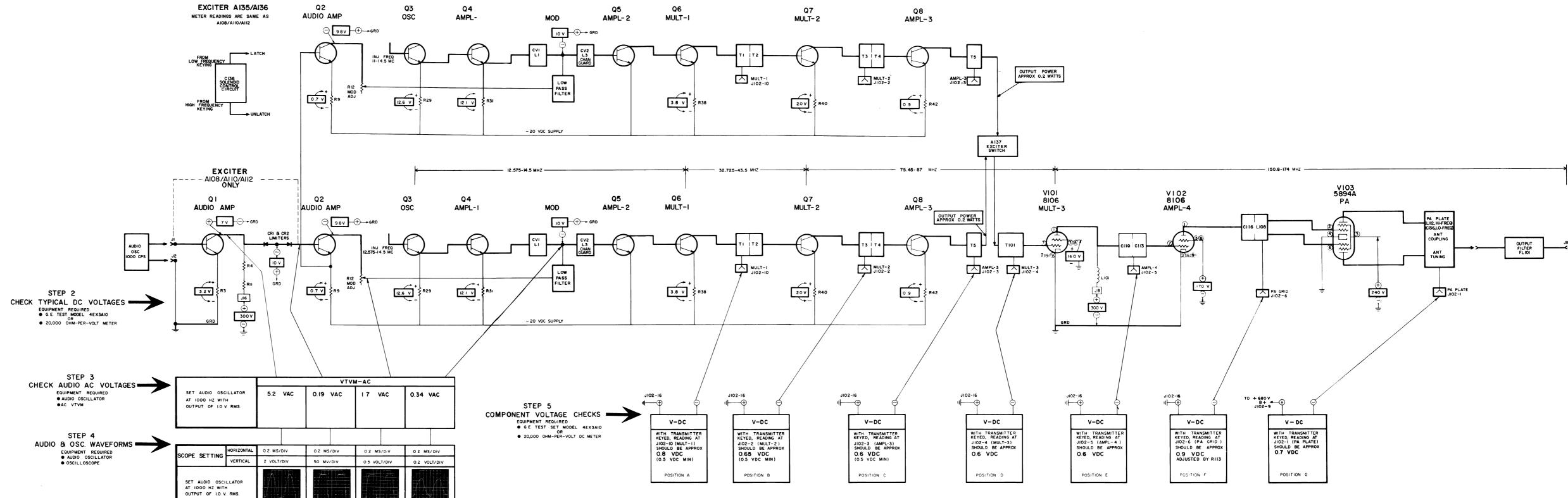


AUDIO OSCILLATOR

voltage and temperature.

STEP I - QUICK CHECKS

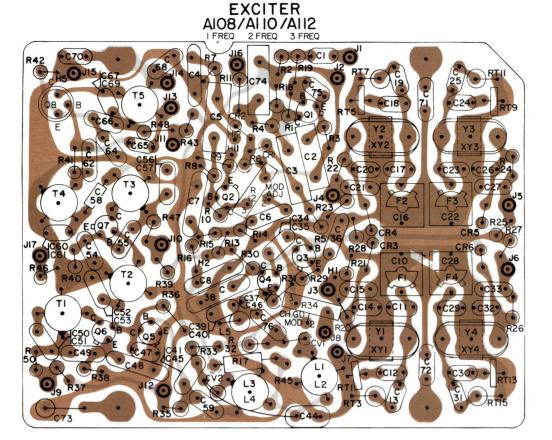
POWER OUTPUT	СНЕ	CK VOLTA		NTRALIZE ter= pin Set= A-G	numbers		J102	PROBABLE DEFECT
	Pins 10 & 16 A	Pins 2 & 16 B	Pins 3 & 16 C	Pins 4 & 16 D	Pins 5 & 16 E	Pins 6 & 14 F	Pins 1 & 9 G	
Low	0.8V	0. 6 5V	0.6V	0.6V	0.55V	Low	0.7V	Weak 5894A or Loose Hardware in output tank circuit, or ba filter.
0	0.8V	0.65V	0.6V	0.6V	0.55V	.37V	0	Open 5894A
0	0.8V	0.65V	Low	.18V	0	.37V	0	Open Filament on 8106
0	0.8V	0.65V	0 or over 1.0V	.18V	0	.37V	0	Defective Q8
0	0.8V	0 or over 1.0V	0	.18V	.77	.37V	0	Defective Q7
0	over	0	0	.18V	0	.37V	0	Shorted Q6 or Open Q5
0	0	0	0	.18V	0	.37V	0	Defective Q3-Q6 or Modulator (see Note A)
NOTE	A Loc	alize t	ouble by	checking	:			
1.	-20	volt DO	Supply a	at J102-1	2-16.			
2.	Mea	sure 12	.1 VDC acı	coss Q4 e	mitter r	esistor	R31 (1500	ohms), then:
(stal- a sloperating			n R31 vo	oltage rea	ding indicates Q3 and
((b) If	no volta	age is mea	asured, c	heck key	ing lead	is CR3-CR6	6, Q3, Q4.
(1.0							oltage reading above Defect may be in
	(d) If	modulate	or is defe	ective, c	heck vol	tage va	riable dic	odes CV1 and CV2.



RC-1294

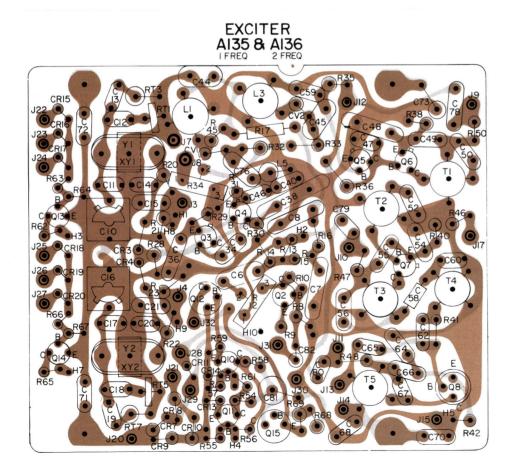
TROUBLESHOOTING PROCEDURE

150.8—174 MHz, 80-WATT MASTR TRANSMITTER MODELS 4ET58J10-12



(19C317278, Sh. 1, Rev. 2) (19C317278, Sh. 2, Rev. 2)

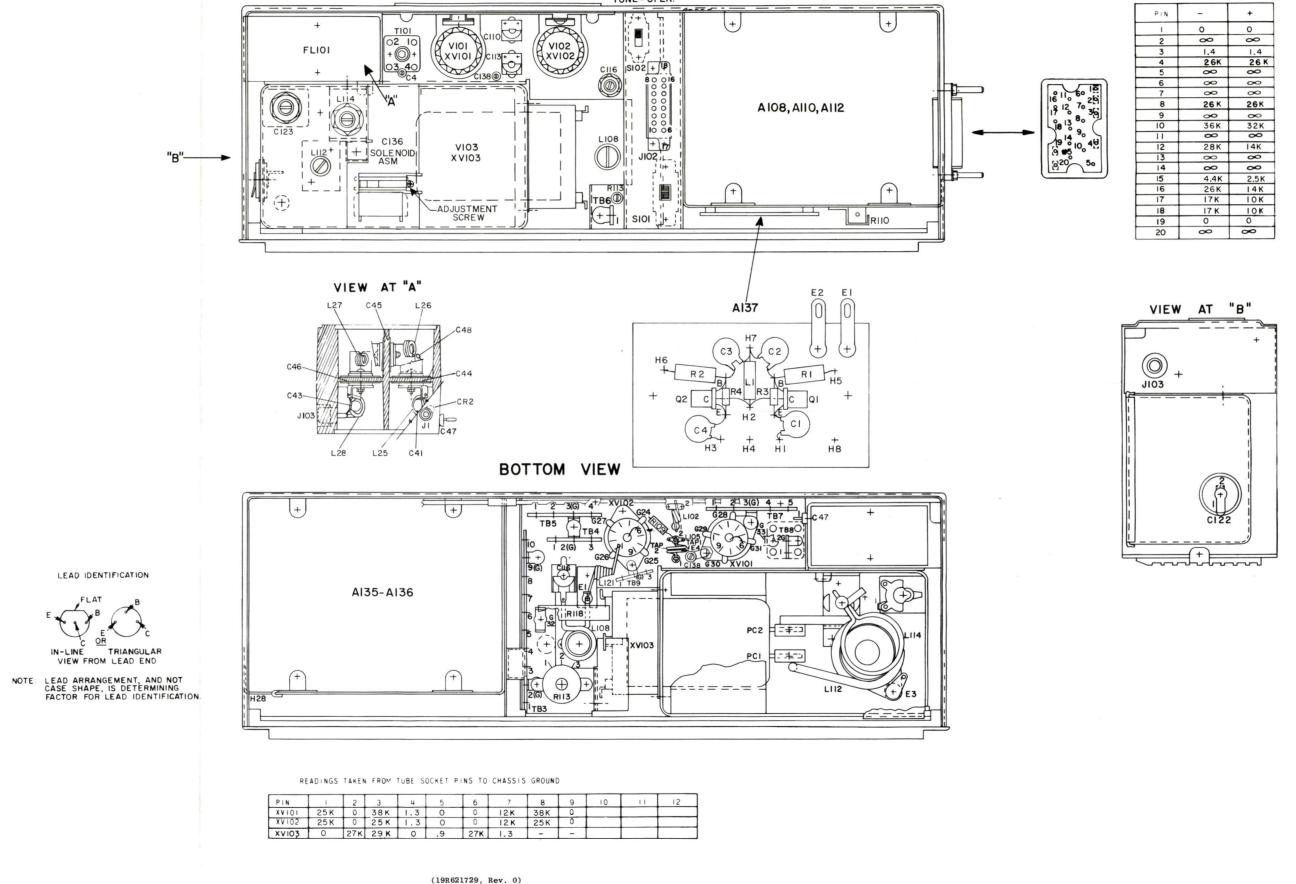
RUNS ON SOLDER SIDE - RUNS ON BOTH SIDES



OUTLINE DIAGRAM

150.8—174 MHz MASTR TRANSMITTER MODELS 4ET58J10-12

Issue 1



PEACINGS AT JIOI TAKEN TO CHASSIS GROUND.

TOP VIEW

PARTS	LIST
LBI-4	305

150.8-174 MHz TRANSMITTER MODEL 4ET58J10-J12

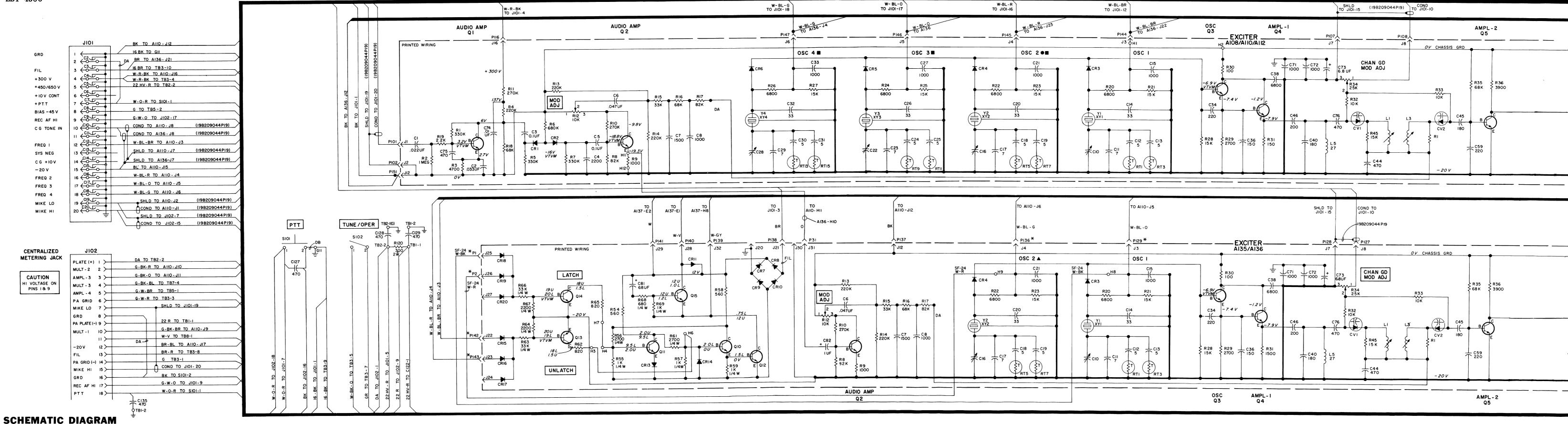
C12 and C13 C14 5496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C15 5494481P111 C16 5491271P106 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C17 5496219P7 C18 C19 C19 C19 C19 C19 C10 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C19 C10 C10 C11 C11 C12 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C11 C12 C13 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C14 C15 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C20 Ceramic disc: .33 pf ±5%, 500 VDCW, temp C21 Ceramic disc: .33 pf ±5%, 500 VDCW, temp C22 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C23 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp C24 and C25 C26 C27 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp C28 C29 C29 C494481P11 Ceramic disc: .33 pf ±5%, 500 VDCW, temp C29 C29 C496219P7 Ceramic disc: .33 pf ±5%, 500 VDCW, temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C20 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C21 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C22 C23 C24 C25 C26 C27 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C28 C496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW, temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW, temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW, temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW, temp C29 Ceramic disc: .001 pf ±20%, 1000 VDCW, temp C29	SYMBOL	GE PART NO.	DESCRIPTION
C1 19A116080P3 Polyester: .022 µf ±20%, 50 VDCW. C2 19A116080P4 Polyester: .033 µf ±20%, 50 VDCW. C3 19A116080P7 Polyester: .0.1 µf ±20%, 50 VDCW. C4 7491395P114 Ceramic disc: .0022 pf ±10%, 500 VDCW. C5 19A116080P7 Polyester: 0.1 µf ±20%, 50 VDCW. C6 19A116080P7 Polyester: .0.4 µf ±20%, 50 VDCW. C7 7491395P111 Ceramic disc: .0015 pf ±10%, 500 VDCW. C8 5493367P1000K Silver mica: .0010 pf ±10%, 500 VDCW. C8 5493367P1000K Silver mica: .0010 pf ±10%, 100 VDCW; sim to Electro Motive Type DM-20. C10 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 780 v peak; sim to EF Johnson 189. C11 5496219P7 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp co of 0 PPM. C12 19C300685P93 Ceramic disc: 30 pf ±20%, 1000 VDCW, temp co of -750 PPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to REC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 780 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp co of 0 PPM. C18 19C300685P93 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of 0 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to REC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 730 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C25 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of -750 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of -750 PPM. C27 5494481P111 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C28 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C30 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C30 19C300685P93 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of 0 PPM. C30 19C300685P93 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of 0 PPM. C30 19C300685P93 Ceramic disc: 3	A112, A135		A108 19D402308G8 A110 19D402308G10 A112 19D402308G12 A135 19D402308G21
19A116080P4 Polyester: .033 μf ±20%, 50 VDCW.			CAPACITORS
C3 19A116080P7 Polyester: 0.1 µf ±20%, 50 VDCW. C4 7491395P114 Ceramic disc: .0022 pf ±10%, 500 VDCW. C5 19A116080P5 Polyester: 0.1 µf ±20%, 50 VDCW. C6 19A116080P5 Polyester: .047 µf ±20%, 50 VDCW. C7 7491395P111 Ceramic disc: .0015 pf ±10%, 500 VDCW. C8 5493367P1000K Silver mica: .001 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-20. C10 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C11 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co of PPM. C12 19C300685P93 coef o PPM. C13 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C18 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P75 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P75 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C27 5494481P111 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C28 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P751 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C31 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to CPM. C32 5496			
C4 7491395P114 Ceramic disc: .0022 pf ±10%, 500 VDCW. C5 19A116080P7 Polyester: 0.1 μf ±20%, 50 VDCW. C6 19A116080P5 Polyester: .047 μf ±20%, 50 VDCW. C7 7491395P111 Ceramic disc: .0015 pf ±10%, 500 VDCW. C8 5493367P1000K Silver mica: .001 pf ±10%, 100 VDCW; sim to Electro Motive Type DM-20. C10 549127IP106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C11 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co of PPM. C12 19C300685P93 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co of -750 PPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C16 549127IP106 Variable, subminiature: approx 2.1-12.7 pf, 780 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C18 19C300685P93 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C18 19C300685P93 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C20 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C21 5494481P111 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C22 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C23 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C24 19C300685P93 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp co of 0 PPM. C25 5496219P751 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C26 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C27 5494481P111 Ceramic disc: .33 pf ±5%, 500 VDCW, temp co of 0 PPM. C28 5496219P751 Ceramic disc: .5 pf ±0.5 pf, 500 VDCW, temp co of 0 PPM. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp co of 0 PPM. C30 19C300685P93 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp co of 0 PPM. C30 19C300685P93 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to 0 PPM. C30 19C300685P93 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to 0 PPM. C30			
C5			
C6 19A116080P5 C7 7491395P111 C8 5493367P1000K Silver mica: .0015 pf ±10%, 500 VDCW. Silver mica: .001 pf ±10%, 100 VDCW; sim to Electro Motive Type DM-20. C10 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C11 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co of OPPM. C12 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp co of OPPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C21 5494481P111 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C24 19C300685P93 C25 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C27 5494481P111 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C28 5496219P7 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef -750 PPM. C29 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef -750 PPM. C29 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EMC Type JF Discap. C29 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp coef 0 PPM. C31 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp coef 0 PPM. C32 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp coef 0 PPM. C33 54964481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to CERAMIC disc: .001 pf ±20%, 1000 VDCW; sim to CERAMIC disc: .001 p			· '
S493367P1000K Silver mica: .001 pf ±10%, 100 VDCW; sim to Electro Motive Type DM-20.	C6	19A116080P5	
S491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189.	C7	7491395P111	Ceramic disc: .0015 pf ±10%, 500 VDCW.
C11 5496219P7 Ceramic disc: 5 pf i0.5 pf, 500 VDCW, temp co oppM. C12 19C300685P93 Ceramic disc: 5 pf i0.1 pf, 500 VDCW, temp co of 0 PPM. C13 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co fo PPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C27 5494481P111 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C28 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 750 PPM. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C29 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 5496219P751 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EF Dohnson 189.	C8	5493367P1000K	
C12 and C13 C14 S496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C15 S494481P11 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C16 S491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 l9C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 S496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef coef 0 PPM. C21 S494481P11 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 S491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 S496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 l9C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C25 C26 S496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C27 S494481P11 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 S496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 S491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 S496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 S496219P751 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 l9C300685P93 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C31 C32 S496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C33 S494481P11 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C33 S494481P11 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to	C10	5491271P106	
coef 0 PPM. C14 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C29 5496219P7 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef -750 PPM.	C11	5496219P7	Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coe 0 PPM.
Coef -750 PPM. C15 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C26 5496219P751 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5496219P7 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: .7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P7 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P7 Ceramic disc: .5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 5494481P111 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef 0 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW	and	19C300685P93	
C16 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5496219P7 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C31 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 54964481P111 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C33 54964481P111 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM.	C14	5496219P751	
C17 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C18 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5496219P7 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: .01 pf ±20%, 1000 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C33 54964481P111 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic di	C15	5494481P111	
C18 and C19 C20 5496219P751	C16	5491271P106	
Coef 0 PPM. C20 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C33 54964481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to EF Johnson 189.	C17	5496219P7	Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM.
C21 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co 0 PPM. C24 and c25 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp co 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co 0 co 0 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp co 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp co 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co 0 PPM. C32 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp co 0 PPM. C33 5496448P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to 0 PPM.	and	19C300685P93	
C22 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co 0 PPM. C24 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C25 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .0	C20	5496219P751	
C23 5496219P7 Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co 0 PPM. C24 and c25 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ce	C21	5494481P111	
C24 and C25 C26 5496219P751 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: .33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 54964481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to Ceramic disc: .001 pf ±20%, 100	C22	5491271P106	
and C25 coef 0 PPM. C26 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 54944481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to coef -750 PPM.	C23	5496219P7	Ceramic disc: 5 pf ±0.5 pf, 500 VDCW, temp co
C27 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C32 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to coef -750 PPM.	and	19C300685P93	
RMC Type JF Discap. C28 5491271P106 Variable, subminiature: approx 2.1-12.7 pf, 750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to	C26	5496219P751	
750 v peak; sim to EF Johnson 189. C29 5496219P7 Ceramic disc: 7 pf ±0.5 pf, 500 VDCW, temp coef 0 PPM. C30 19C300685P93 Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM. C31 5496219P751 Ceramic disc: 33 pf ±5%, 500 VDCW, temp coef -750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to	C27	5494481P111	Ceramic disc: .001 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
Coef 0 PPM. Coef 0 PPM. Ceramic disc: 5 pf ±0.1 pf, 500 VDCW, temp coef 0 PPM.	C28	5491271P106	
and C31	C29	5496219P7	
-750 PPM. C33 5494481P111 Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to	and	19C300685P93	
	C32	5496219P751	
	C33	5494481P111	Ceramic disc: .001 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.

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SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
C34	5496372P50	Ceramic disc: 220 pf ±5%, 500 VDCW, temp coef -2200 PPM.	CR7	4037822P1	Silicon.
C36	5496219P467	Ceramic disc: 150 pf ±5%, 500 VDCW, temp coef -220 PPM.	CR10	10411525001	Stiteon
C38	5494481P131	Ceramic disc: 6800 pf ±20%, 1000 VDCW; sim	CR11 CR13	19A115250P1 19A115250P1	Silicon.
C40	5496372P345	to RMC Type JF Discap. Ceramic disc: 180 pf ±10%, 500 VDCW, temp	thru CR20		
C40	3490372P343	coef -4700 PPM.	CV1 and	5495769P8	Silicon, capacitive.
C44	5493366P470J	Silver mica: 470 pf ±5%, 100 VDCW; sim to Electro Motive Type DM-15.	CV2		
C45	5496372P45	Ceramic disc: 180 pf ±10%, 500 VDCW, temp coef -2200 PPM.	Jı	4033513P4	JACKS AND RECEPTACLES Contact, electrical; sim to Bead Chain L93-3.
C46	5496372P347	Ceramic disc: 200 pf ±10%, 500 VDCW, temp coef -4700 PPM.	thru J17		
C47	5496219P749	Ceramic disc: 27 pf ±5%, 500 VDCW, temp coef -750 PPM.	J20 thru J32	4033513P4	Contact, electrical; sim to Bead Chain L93-3.
C48	5494481P129	Ceramic disc: 3900 pf ±20%, 1000 VDCW; sim	""		
C49	5494481P111	to RMC Type JF Discap. Ceramic disc: .001 pf ±20%, 1000 VDCW; sim	L1	19B204526G2	Coil. Includes tuning slug 5491798P2.
0.25	01311017111	to RMC Type JF Discap.	L3	19B204526G4	Coil. Includes tuning slug 5491798P2.
C50	5496219P253	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef -80 PPM.	R1	3R152P333J	Composition: 33,000 ohms ±5%, 1/4 w.
C52	5496219P253	Ceramic disc: 39 pf ±5%, 500 VDCW, temp coef -80 PPM.	L5	7488079P48	Choke, RF: 27 µh ±10%, 1.4 ohms DC res; sim to Jeffers 4422-9K.
C54 and	5494481P111	Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.			
C55			Pl and	4029840P2	Contact, electrical: sim to Amp 42827-2.
C56	5496219P440	Ceramic disc: 9 pf ±0.25 pf, 500 VDCW, temp coef -220 PPM.	P2 P31	4029840P2	Contact, electrical: sim to Amp 42827-2.
C58	5491601P35	Tubular: 0.15 pf ±10%, 500 VDCW; sim to Quality Components Type MC.			TRANSISTORS
C59	5493366P220K	Silver mica: 220 pf ±10%, 100 VDCW; sim to Electro Motive Type DM-15.	Q1 and	19A115123P1	Silicon, NPN; sim to Type 2N2712.
C60	5496219P241	Ceramic disc: 10 pf ±5%, 500 VDCW, temp coef -80 PPM.	Q2		
C62	5496219P51	Ceramic disc: 33 pf $\pm 5\%$, 500 VDCW, temp coef 0 PPM.	Q3 thru Q5	19A115330P1	Silicon, NPN.
C64	5494481P111	Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	Q6 and	19A115328P1	Silicon, NPN.
C65	5496219P35	Ceramic disc: 4 pf ± 0.25 pf, 500 VDCW, temp coef 0 PPM.	Q7 Q8	19A115329P1	Silicon, NPN.
C66	5494481P111	Ceramic disc: .001 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.	Q10 and	19A115123P1	Silicon, NPN; sim to Type 2N2712.
C67	5496219P247	Ceramic disc: 22 pf $\pm 5\%$, 500 VDCW, temp coef -80 PPM.	Q11 Q12	19A115300P2	Silicon, NPN; sim to Type 2N3053.
C68	5494481P111	Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	Q13 and	19A115123P1	Silicon, NPN; sim to Type 2N2712.
C70	5494481P111	Ceramic disc: .001 pf ±20%, 1000 VDCW; sim to	Q14		
thru C72		RMC Type JF Discap.	Q15	19A115300P2	Silicon, NPN; sim to Type 2N3053.
C73	5496267P18	Tantalum: 6.8 µf ±20%, 35 VDCW; sim to Sprague Type 150D.			
C74	19A115414P13	Tubular, polyester: 0.1 μf ±20%, 200 VDCW.	R1	3R77P334K	Composition: 0.33 megohm ±10%, 1/2 w.
C75	5494481P107	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RM Type JF Discap.	R2	3R77P105K	Composition: 1 megohm ±10%, 1/2 w.
C76	5493366P470K	Mica: 470 pf ±10%, 100 VDCW; sim to Electro	R3	3R77P472K 3R77P224K	Composition: 4700 ohms ±10%, 1/2 w.
		Motive Type DM-15.	R5	3R77P334K	Composition: 0.22 megohm ±10%, 1/2 w. Composition: 0.33 megohm ±10%, 1/2 w.
C79 and	5494481P111	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.	R6	3R77P684K	Composition: 0.68 megohm ±10%, 1/2 w.
C80			R7	3R77P334K	Composition: 0.33 megohm ±10%, 1/2 w.
C81	5496267P11	Tantalum: 68 µf ±20%, 15 VDCW; sim to Sprague Type 150D.	R8	3R77P823K	Composition: 82,000 ohms ±10%, 1/2 w.
C82	5496267P17	Tantalum: 1.0 µf ±20%, 35 VDCW; sim to	R9	3R77P102K	Composition: 1000 ohms ±10%, 1/2 w.
		Sprague Type 150D.	R10 and	3R77P274K	Composition: 0.27 megohm ±10%, 1/2 w.
		DIODES AND RECTIFIERS	R11		
CR1 and CR2	19A115250P1	Silicon.	R12	19B209358P106	Variable, carbon film: approx 75 to 10,000 oh ±10%, 0.25 w; sim to CTS Type X-201.
CR3 thru CR6	19A115603P1	Silicon.	R13 and R14	3R77P224K	Composition: 0.22 megohm ±10%, 1/2 w.
			R15	3R77P333K	Composition: 33,000 ohms ±10%, 1/2 w.

SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART N
R16	3R77P683K	Composition: 68,000 ohms ±10%, 1/2 w.	RT5	19B209284P6
R17	3R77P823K	Composition: 82,000 ohms ±10%, 1/2 w.	RT7	19B209284P2
R18	3R77P683K	Composition: 68,000 ohms ±10%, 1/2 w.		
R19	3R77P222K	Composition: 2200 ohms ±10%, 1/2 w.	RT9	19B209284P6
R 20	3R77P682K	Composition: 6800 ohms ±10%, 1/2 w.	RT11	19B209284P2
R21	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.		
R 22	3R77P682K	Composition: 6800 ohms ±10%, 1/2 w.	RT13	19B209284P6
R23	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.	RT15	19B209284P2
R24	3R77P682K	Composition: 6800 ohms ±10%, 1/2 w.		
R 25	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.	1 1	
R 26	3R77P682K	Composition: 6800 ohms ±10%, 1/2 w.	Tl	19B204534G1
R27 and	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.	Т2	19B204531G
R28			Т3	19B204535G
R29	3R77P272K	Composition: 2700 ohms ±10%, 1/2 w.	Т4	19B204535G
R30	3R77P101K	Composition: 100 ohms ±10%, 1/2 w.	т5	19B204537G
R31	3R77P152K	Composition: 1500 ohms ±10%, 1/2 w.		
R32 and	3R77P103K	Composition: 10,000 ohms ±10%, 1/2 w.	XY1	
R33			thru XY4	
R34	19B209358P107	Variable, carbon film: approx 75 to 25,000 ohms ±10%, 0.25 w; sim to CTS Type X-201.	A14	
R35	3R77P683K	Composition: 68,000 ohms ±10%, 1/2 w.		
R36	3R77P392K	Composition: 3900 ohms ±10%, 1/2 w.		
R37	3R77P750J	Composition: 75 ohms ±5%, 1/2 w.		
R38	3R77P391K	Composition: 390 ohms ±10%, 1/2 w.	Y1 thru	19B206175P
R39	3R77P620J	Composition: 62 ohms ±5%, 1/2 w.	Y4	
R40	3R77P181K	Composition: 180 ohms ±10%, 1/2 w.	A137	
R41	3R77P470K	Composition: 47 ohms ±10%, 1/2 w.	A13'	
R42	3R77P270K	Composition: 27 ohms ±10%, 1/2 w.		
R43	3R77P200J	Composition: 20 ohms ±5%, 1/2 w.	a a	5494481P8
R45	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.		249440116
R46	19A116278P474	Metal film: 576,000 ohms ±2%, 1/2 w.	C2 and	5496218P45
R47	3R77P391K	Composition: 390 ohms ±10%, 1/2 w.	C3	Ì
R48	3R77P470K	Composition: 47 ohms ±10%, 1/2 w.	C4	5494481P8
R50	3R77P101K	Composition: 100 ohms ±10%, 1/2 w.		ļ
R54	3R77P561K	Composition: 560 ohms ±10%, 1/2 w.		1
R55	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.	Lı	7488079P6
R56	3R152P272K	Composition: 2700 ohms ±10%, 1/4 w.		
R57	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.	1	
R58	3R77P561K	Composition: 560 ohms ±10%, 1/4 w.	P118	4029840P2
R59	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.	P119	4029840P1
R61	3R152P272K	Composition: 2700 ohms ±10%, 1/4 w.	P120	4029840P2
R62	3R77P821K	Composition: 820 ohms ±10%, 1/4 w.	P121	4029840P1
R63	3R152P333K	Composition: 33,000 ohms ±10%, 1/4 w.	11	
R64	3R152P222K	Composition: 2200 ohms ±10%, 1/4 w.	Q1	19A115910
R65	3R77P821K	Composition: 820 ohms ±10%, 1/4 w.	and Q2	
R66	3R152P333K	Composition: 33,000 ohms ±10%, 1/4 w.	`	
R67	3R152P222K	Composition: 2200 ohms ±10%, 1/4 w.	R1	3R77P333K
R68	3R152P681K	Composition: 680 ohms ±10%, 1/4 w.	and R2	
R69	3R152P102K	Composition: 1000 ohms ±10%, 1/4 w.	R3	3R152P470
			and R4	
2.00	10000000100		"	İ
RTl	19B209284P6	Disc: 75 ohms res nominal at 25°C, color code blue.	11	
	19B209284P2	Rod: 21,400 ohms res nominal at 25°C, color	 	1
RT3		code red.	1 1	ı
RT3			11	1
RT3			C101	5494481P7
RT3			C101 and C102	5494481P7

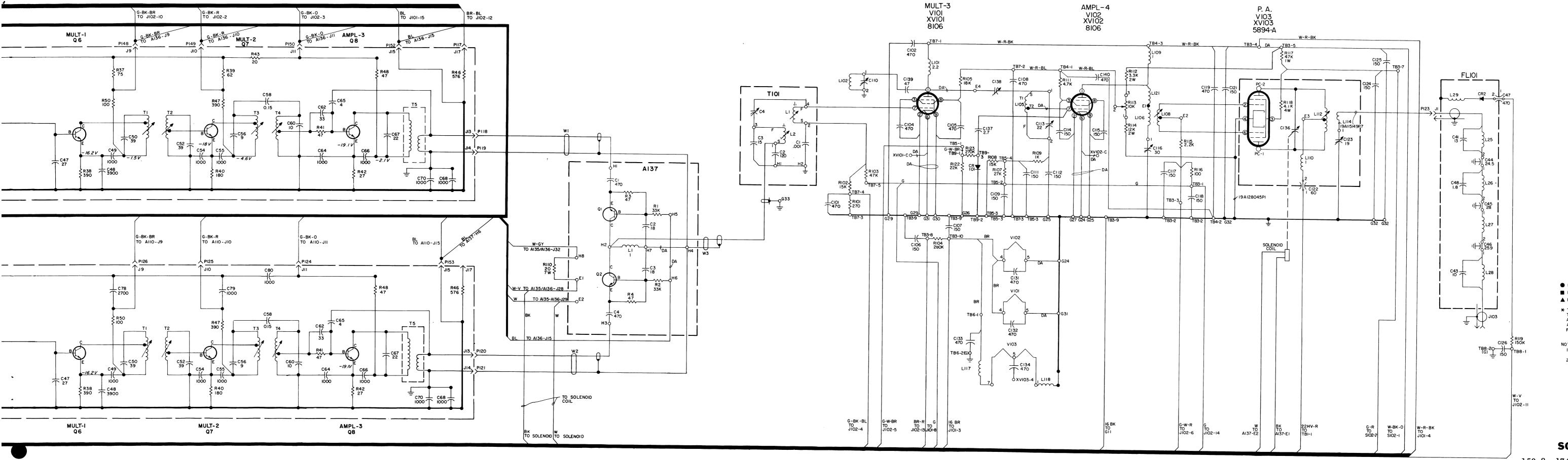
DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
c: 75 ohms res nominal at 25°C, color code	C104 and C105	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
: 21,400 ohms res nominal at 25°C, color e red. c: 75 ohms res nominal at 25°C, color code	C106 and C107	5494481P1	Ceramic disc: 150 pf $\pm 20\%$, 1000 VDCW; sim to RMC Type JF Discap.
e. : 21,400 ohms res nominal at 25°C, color	C108	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
e red. c: 75 ohms res nominal at 25°C, color code	C109	5494481P1	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
e.	C110	19Al16480P5	Variable: approx than 2.8 to 22 pf, 500 VDCW; sim to EF Johnson 189.
le red.	Clll and	5494481P1	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
TRANSFORMERS	C112 C113	19A116480P5	Variable: approx than 2.8 to 22 pf, 500 VDCW;
1. Includes tuning slug 5491798P4.		540440333	sim to EF Johnson 189.
1. Includes tuning slug 5491798P4.	C114 and C115	5494481P1	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
1. Includes tuning slug 5491798P4. 1. Includes tuning slug 5491798P4.	C116	19B209328P10	Variable: approx 2.62 to 30.6 pf; sim to EF Johnson Type V 193-10-2.
SOCKETS	Cll7	5494481P1	Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
fer to Mechanical Parts (RC-2210).	C118 C119	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to
	C121	5494481P1	RMC Type JF Discap. Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to
en reordering give GE Part No. and specify	C122		RMC Type JF Discap. (Part of Mechanical Parts, see RC-2210).
vstal Freq = (OF * 12).	C123	7491398P5	Variable, air: approx 4.0-19 pf; sim to
rtz: freq range 12,500 to 14,500 KHz, temp ge -30°C to +85°C. (150.8-174 MHz Transmitter).	Cl24 thru	5494481P1	Teleradio T-9974-M. Ceramic disc: 150 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
COMPONENT BOARD 19B219181G1	Cl26 Cl27 thru	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
CAPACITORS	C129 C131	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to
amic disc: 470 pf ±10%, 1000 VDCW; sim to Type JF Discap.	thru Cl35		RMC Type JF Discap.
amic disc: 18 pf ±5%, 500 VDCW, temp	C136	19C317700G1	Solenoid Assembly.
f O PPM.	C137 C138	5491601P28 19A116554P1	Phenolic: 2.7 pf ±10%, 500 VDCW.
amic disc: 470 pf ±10%, 1000 VDCW; sim to Type JF Discap.			Variable: 0.3 to 1.5 pf, 500 VDCW, +125 -250 PPM/°C.
INDUCTORS	C139	5496218P317	Ceramic disc: 47 pf ±10%, 500 VDCW, temp coef -150 PPM.
oke, RF: 1.00 μh ±10%, 0.30 ohms DC res max; i to Jeffers 4411-8K.	C140	5494481P7	Ceramic disc: 470 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
	CR101	,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	DIODES AND RECTIFIERS
ntact, electrical: sim to Amp 42827-2.	Carror Carror	19A115250P1	Silicon.
ntact, electrical: sim to AMP 41854.			
tact, electrical: sim to Amp 42827-2.	FL101		LOW PASS FILTER ASSEMBLY 19D402233G10
TRANSISTORS			The low pass filter is factory tuned. If it is found to be defective it is recommended
licon, NPN; sim to Type 2N3904.			that the entire filter assembly be replaced to maintain rated power output and spurious attenuation.
RESISTORS			
mposition: 33,000 ohms ±10%, 1/2 w.	El	19A127909G1	Terminal.
	E3	4036994P1	Terminal, solder: sim to Zierick Mfg Corp 505.
mposition: 47 ohms ±10%, 1/4 w.			JACKS AND RECEPTACLES
	J101	19C303426G1	Connector: 20 pin contacts.
CHASSIS AND PA ASSEMBLY 19E500926G3	J102 J103	19B205689G1	Connector: 18 contacts. (Part of FL101).
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SYMBOL	GE PART NO.	DESCRIPTION	SYMBOL	GE PART NO.	DESCRIPTION
		INDUCTORS	R122	3R77P223K	Composition: 22,000 ohms ±10%, 1/2 w.
L101	7488079P8	Choke, RF: 2.2 μh $\pm 10\%$, 1 ohm DC res; sim to Jeffers 4411-12K.	R123	3R77P274K	Composition: 0.27 megohm ±10%, 1/2 w.
L102	19A128194P1	Coil.			
L105	19A128037G3	Coil.	\$101	4031922P1	Push: single pole, single throw, normally open, 1/2 amp at 12 VDC; sim to Stackpole
L106	19B219005P1	Coil.			Type SS-15.
L108	19B219341G1	Coil. Includes R115.	S102	19B209040P1	Slide: DPDT, 0.5 amp at 125 v; sim to Continental Wirt Type 126.
L109 and L110	7488079P6	Choke, RF: 1.00 µh ±10%, 0.30 ohms DC res max; sim to Jeffers 4411-8K.			TRANSFORMERS
L112	19B219009G1	Coil.	T101		COIL ASSEMBLY
L114	19B219028G1	Coil.		i ·	19B219012G1
Lll7 and Lll8	19A128034P1	Coil.			
L121	19A128035P3	Coil.	Cl	5494481P11	Ceramic disc: 1000 pf ±20%, 1000 VDCW; sim to RMC Type JF Discap.
			C2	7489162P129	Silver mica: 120 pf ±10%, 500 VDCW; sim to Electro Motive Type DM-15.
P101 P102	4029840P2 4029840P1	Contact, electrical; sim to Amp 42827-2.	СЗ	5496218P344	Ceramic disc: 15 pf ±5%, 500 VDCW, temp coef -150 PPM.
P102	4029840P1 4029840P1	Contact, electrical; sim to Amp 41854. Contact, electrical; sim to Amp 41854.	C4	19A116554P1	Variable: 0,3 to 1,5 pf, 500 VDCW, -250 to
P108	4029840P2	Contact, electrical; sim to Amp 42827-2.			+125 PPM/°C.
P114	4029840P1	Contact, electrical; sim to Amp 41854.			INDUCTORS
P116	4029840P2	Contact, electrical; sim to Amp 42827-2.	Ll	19B219011P2	Coil.
and P117			L2	19B219011P1	Coil.
P123	4033513P21	Contact, electrical: sim to Bead Chain R125-22.		1	TERMINAL BOARDS
Pl24 thru	4029840P2	Contact, electrical; sim to Amp 42827-2.	TB1	7487424P2	Miniature, phen: 1 terminal.
P127	400004073		TB2	7487424P1	Miniature, phen: 1 terminal.
P128 P129	4029840P1 4029840P2	Contact, electrical; sim to Amp 41854.	твз	7775500P26	Phen: 10 terminals.
P136	4029840P2	Contact, electrical; sim to Amp 42827-2. Contact, electrical; sim to Amp 42827-2.	TB4	7775500P107	Phen: 3 terminals.
thru P143		0000000, 0100011001, 01m to hmp 12021-2.	TB5	7775500P10	Phen: 4 terminals.
P144	4029840Pl	Contact, electrical; sim to Amp 41854.	TB6	7775500P44 7775500P111	Phen: 2 terminals. Phen: 5 terminals.
thru P153			TB8	7487424P1	Miniature, phen; 1 terminal.
		RESISTORS	тв9	7487424P10	Miniature, phen: 2 terminals.
R101	3R77P271K	Composition: 270 ohms ±10%, 1/2 w.			
R102 R103	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.	V101		TUBES TUBES Type 8106.
R104	3R77P473K 19A116278P444	Composition: 47,000 ohms ±10%, 1/2 w.	and V102		1,50 0100.
R105	3R77P183K	Metal film: 0.28 megohm ±2%, 1/2 w. Composition: 18,000 ohms ±10%, 1/2 w.	V103		Type 5894A.
R107	3R77P273K	Composition: 27,000 ohms ±10%, 1/2 w.			
R108	3R77P153K	Composition: 15,000 ohms ±10%, 1/2 w.	XV101	7480532P8	Tube share 0 state of the Theorem
R109	3R77P102K	Composition: 1000 ohms ±10%, 1/2 w.	and XV102	1400032F6	Tube, phen: 9 pins; sim to Elco 04-903-84.
R110	5493035P20	Wirewound: 20 ohms ±5%, 7 w; sim to Hamilton Hall Type HR.	XV103	7489471P3	Tube, ceramic or steatite: 7 pins.
R111	3R77P472K	Composition: 4700 ohms ±10%, 1/2 w.	1		MECHANICAL PARTS (SEE RC-2210)
R112	19A116479P 2332K	Metal film: 2200 ohms ±10%, 2 w; sim to Mallory Type 2 MOL.	1	19B200525P9	Rivet, (Part of XY1-XY4),
R113	19B209114P7	Variable, wirewound: 10,000 ohms ±20%, 3 w; sim to CTS Series 117.	2	4033089P1	Clip. (Part of XY1-XY4).
R114	3R79P123K	Composition: 12,000 ohms ±10%, 2 w.	3	19A115793P1	Contact, electrical: sim to Malco 2700. (Part of XY1-XY4).
R115		(Part of L108).	4	4038930P1	Clip: approx 13/16 x 13/16 inches.
R116	3R77P101J	Composition: 100 ohms ±5%, 1/2 w.	5	19C311172P2	Crystal socket. (Part of XY1-XY4).
R117 R118	3R78P473K	Composition: 47,000 ohms ±10%, 1 w.	6	19C303395G4	Chassis heat sink.
8118	19A116479P 4412K	Metal film: 4100 ohms ±10%, 4 w; sim to Mallory Type 4 MOL.	7	19C317518G1	Tuning slug. (Part of L108).
R119	3R77P154K	Composition: 0.15 megohm ±10%, 1/2 w.	8	N80P13004C13	Screw, phillips head: No. 6-32 x 1/4.
R120	19A115416P7	Wirewound: 3 ohms $\pm 1\%$, 2 w; sim to Dale Type RS-2B.	10	4035306P35	Fiber washer.
			"	19C317517G2	Tuning chassis.
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150 9 174 MIL MACON TRANSMITTE

150.8—174 MHz MASTR TRANSMITTER MODELS 4ET58J10-12



ALL RESISTORS ARE 1/2 WATT UNLESS OTHERWISE SPECIFIED AND RESISTOR VALUES IN OHMS UNLESS FOLLOWED BY K=1000 000 OHMS. CAPACITOR VALUES IN PICOFARADS (EQUAL TO MICROMICROFARADS) UNLESS FOLLOWED BY UF= MICROFARADS, INDUCTANCE VALUES IN MICROHENRYS UNLESS FOLLOWED BY MH= MILLIHENRYS OR H=HENRYS.

IN ORDER TO RETAIN RATED EQUIPMENT PERFORMANCE, REPLACEMENT OF ANY SERVICE PART SHOULD BE MADE ONLY WITH A COMPONENT HAVING THE SPECIFICATIONS SHOWN ON THE PARTS LIST FOR THAT PART.

SEE APPLICABLE PRODUCTION CHANGE SHEETS IN INSTRUCTION BOOK SECTION DEALING WITH THIS UNIT, FOR DESCRIPTION OF CHANGES UNDER EACH REVISION LETTER.

THIS ELEM DIAG APPLIES TO

MODEL NO REV LETTER
PLI9550092663
A108 - PLI9D40230868 F
A110 - PL19D402308610 F
A112 - PL19D402308610 F
A1135 - PL19D402308621
A136 - PL19D402308621
A136 - PL19D402308622
A137 - PL19B21918161

- PRESENT IN AIIO
- PRESENT IN AII2
- A PRESENT IN A136
- * THE CONNECTIONS TO AI36-J3, J4 AND J22 THRU J27 VARY WITH TRANSMITTER MODEL AND FREQUENCY ARRANGEMENT CONNECTIONS ARE SHOWN FOR FI & F2 IN LO SUB BAND AND F3 & F4 IN HIGH SUB BAND.

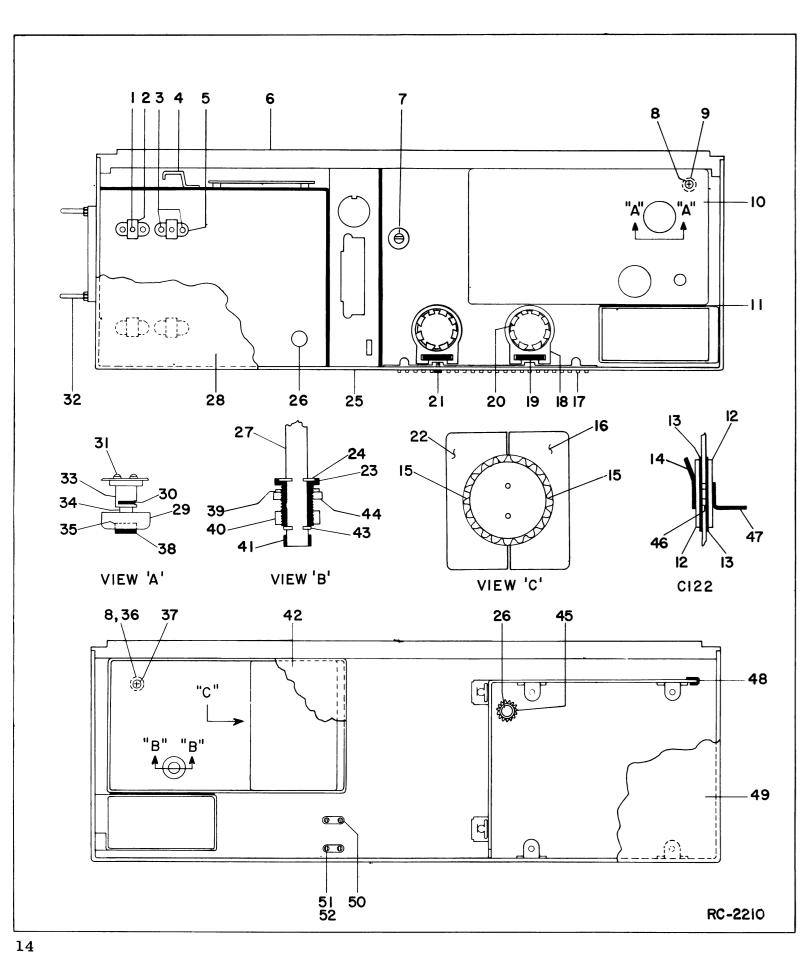
OTES:

- ALL WIRES ARE N22 UNLESS OTHERWISE SPECIFIED.
- 2. ALL 22R WIRE IS A4036780P3.

SCHEMATIC DIAGRAM

150.8—174 MHz MASTR TRANSMITTER MODELS 4ET58J10-12

LBI-4306



(Cont'd from Pg. 11)

aluminum. (Part of C122). teflon. (Part of C122). 1, solderless. (Part of C122). ield insert. (Part of V103- a quantity required). nk. (Lower) (Used with V103). nk. nk. (Used with V101 and V102). (Used with V101 and V102). ield insert: sim to Atlas 106-332-5. ith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on A10 121-A126). (Part of PA Plate Assembly).
teflon. (Part of Cl22). 1, solderless. (Part of Cl22). ield insert. (Part of Vl03- a quantity required). nk. (Lower) (Used with Vl03). nk. (Used with Vl01 and Vl02). (Used with Vl01 and Vl02). ield insert: sim to Atlas 106-332-5. iith Vl01 and Vl02). ew: 4-40 x 3/16. nk. (Upper) (Used with Vl03). (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on Al0 121-Al26). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly).
teflon. (Part of Cl22). 1, solderless. (Part of Cl22). ield insert. (Part of Vl03- a quantity required). nk. (Lower) (Used with Vl03). nk. (Used with Vl01 and Vl02). (Used with Vl01 and Vl02). ield insert: sim to Atlas 106-332-5. iith Vl01 and Vl02). ew: 4-40 x 3/16. nk. (Upper) (Used with Vl03). (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on Al0 121-Al26). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly).
teflon. (Part of Cl22). 1, solderless. (Part of Cl22). ield insert. (Part of Vl03- a quantity required). nk. (Lower) (Used with Vl03). nk. (Used with Vl01 and Vl02). (Used with Vl01 and Vl02). ield insert: sim to Atlas 106-332-5. iith Vl01 and Vl02). ew: 4-40 x 3/16. nk. (Upper) (Used with Vl03). (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on Al0 121-Al26). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly).
nl, solderless. (Part of Cl22). ield insert. (Part of Vl03- a quantity required). nk. (Lower) (Used with Vl03). nk. nk. (Used with Vl01 and Vl02). (Used with Vl01 and Vl02). ield insert: sim to Atlas 106-332-5. iith Vl01 and Vl02). ew: 4-40 x 3/16. nk. (Upper) (Used with Vl03). . (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on Al0 121-Al26). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
ield insert. (Part of V103- a quantity required). nk. (Lower) (Used with V103). nk. nk. (Used with V101 and V102). (Used with V101 and V102). ield insert: sim to Atlas 106-332-5. ith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). cor disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly).
required). nk. (Lower) (Used with V103). nk. nk. (Used with V101 and V102). (Used with V101 and V102). ield insert: sim to Atlas 106-332-5. ith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). . (Part of Post assembly). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). in. (Used with J101). . (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
nk. (Used with V101 and V102). (Used with V101 and V102). ield insert: sim to Atlas 106-332-5. iith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). (Part of Post assembly). her. (Part of Post assembly). or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
(Used with V101 and V102). (Used with V101 and V102). ield insert: sim to Atlas 106-332-5. iith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). (Part of Post assembly). her. (Part of Post assembly). or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
(Used with V101 and V102). ield insert: sim to Atlas 106-332-5. ith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). . or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
ield insert: sim to Atlas 106-332-5. ith V101 and V102). ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). . (Part of Post assembly). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
ew: 4-40 x 3/16. nk. (Upper) (Used with V103). . (Part of Post assembly). her. (Part of Post assembly). . or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
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her. (Part of Post assembly). or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
or disc: nylon. (Used with Q8 on A10 121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
121-A126). (Part of Post assembly). top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
top cover. Part of PA Plate Assembly). (Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
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(Part of PA Plate Assembly). phillips head: 8-32 x 1/4. in. (Used with J101). . (Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
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(Part of PA Plate Assembly). (Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
(Part of PA Plate Assembly). (Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
(Part of PA Plate Assembly). or stop. phillips head: 6-32 x 1/4.
or stop. phillips head: 6-32 x 1/4.
phillips head: 6-32 x 1/4.
pnillips nead: 4-40 x 3/8.
her: sim to Shakeproof 1220-2. (Part
ther: sim to Shakeproof 1220-2. (Partsembly).
: No. 32. (Part of Post Assembly).
(Part of Post Assembly).
cover.
ng ring. (Part of Post Assembly).
(Value of Post Assembly).
nk. (Used with Q8 on Al35 and Al36).
or, teflon.
, rubber.
Bottom Cover.
.l; sim to EF Johnson Q-16.677-001.
machine: brass 0-80 x 3/8. (Used with L105).
rass: 0-80 thread. (Used with L102)

PRODUCTION CHANGES

Changes in the equipment to improve performance or to simplify circuits are identified by a "Revision Letter", which is stamped after the model number of the unit. The revision stamped on the unit includes all previous revisions. Refer to the Parts List for descriptions of parts affected by these revisions.

REV. A thru F Exciter Board Alos, Allo, All2

Incorporated into initial shipment.

REV. A - CHASSIS AND PA ASSEMBLY 19E500926G3

To improve tuning range between 166 and 174 MHz. Changed PA can.

SUB-BAND CONNECTIONS CHART

- PROCEDURE

To change the sub-band frequencies, select the appropriate frequency arrangement, and then install the crystals and make the jumper connections as shown in the applicable Table.

Table I - Instructions for 4ET58J10

Frequency		Sub	Exciter Board	Osc No.	Jumper Chart						
Arrangement	Chan	Band			From	n	С	olor		To A135	
1	F1 F2	Lo Hi	A108 A135	1 1	A108 A108	J3 J4	W W	BL BL	BR R	J22 J3	
2	F1 F2	Hi Lo	A135 A108	1 2	A108 A108	J3 J4	W	BL BL	BR R	J3 J22	
Connect these jumpers as indicated in all units.						J5 J6 H8 H9	W W W	BL BL BK R	O G	J23 J24 J25 J26	

Table II - Instructions for 4ET58J11

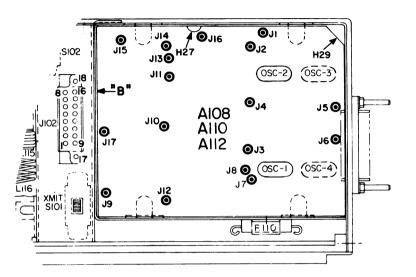
Frequency	Chan Sub Band F1 Hi F2 Hi F3 Lo	1	Exciter Board A136 A136 A110	Osc No.	Jumper Chart						
Arrangement 1					From		Color			To A136	
		Hi			A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J3 J4 J23 J24	
2	F1 F2 F3	Hi Lo Lo	A136 A110 A110	2 3	A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J3 J22 J23 J24	
3	F1 F2 F3	Hi Lo Hi	A136 A110 A136	1 2 2	A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J3 J22 J4 J27	
4	F1 F2 F3	Lo Lo Hi	A110 A110 A136	1 2 1	A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J22 J23 J3 J27	
5	F1 F2 F3	Lo Hi Hi	A110 A136 A136	1 1 2	A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J22 J3 J4 J27	
6	F1 F2 F3	Lo Hi Lo	A110 A136 A110	1 1 3	A110 A110 A110 A110	J3 J4 J5 J6	W W W	BL BL BL BL	BR R O G	J22 J3 J23 J24	
Connect as indicated in all units					A136 A136	H8 H9	W	BK R		J25 J26	

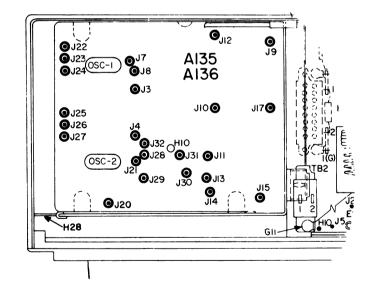
Table III - Instructions for 4ET58J12

Frequency		Sub	Exciter	Osc.	Jumper Chart						
Arrangement	Chan	Band	Board	No.	Fro	m	Color		To A136		
1	F1 F2 F3 F4	Hi Hi Hi Lo	A112 A112 A112 A136	1 2 3 1	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J25 J26 J27 J3 J22 J23	
2	F1 F2 F3 F4	Hi Hi Lo Lo	A136 A136 A112 A112	1 2 3 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL BK R	BR R O G	J3 J4 J22 J23 J25 J26	
3	F1 F2 F3 F4	Hi Lo Lo Lo	A136 A112 A112 A112	1 2 3 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J3 J22 J23 J24 J25 J26	
4	F1 F2 F3 F4	Lo Lo Lo Hi	A112 A112 A112 A136	1 2 3 1	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BK R	BR R O G	J22 J23 J24 J3 J25 J26	
5	F1 F2 F3 F4	Lo Lo Hi Hi	A112 A112 A136 A136	1 2 1 2	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL BK R	BR R O G	J22 J23 J3 J4 J25 J26	
6	F1 F2 F3 F4	Lo Hi Hi Hi	A136 A112 A112 A112	1 2 3 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J3 J25 J26 J27 J22 J23	
7	F1 F2 F3 F4	Hi Hi Lo Hi	A112 A112 A136 A112	1 2 1 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL BK R	BR R O G	J25 J26 J3 J27 J22 J23	

Table III - Continued

Frequency		Sub	Exciter	0sc						
Arrangement	Chan	Band	Board	No.	From		Color			To A136
8	F1 F2 F3 F4	Hi Lo Hi Hi	A112 A136 A112 A112	1 1 3 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BK R	BR R O G	J25 J3 J26 J27 J22 J23
9	F1 F2 F3 F4	Hi Lo Lo Hi	A136 A112 A112 A136	1 2 3 2	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J3 J22 J23 J4 J25 J26
10	F1 F2 F3 F4	Lo Hi Hi Lo	A112 A136 A136 A112	1 1 2 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL BK R	BR R O G	J22 J3 J4 J23 J25 J26
11	F1 F2 F3 F4	Lo Hi Lo Lo	A112 A136 A112 A112	1 1 3 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BK R	BR R O G	J22 J3 J23 J24 J25 J26
12	F1 F2 F3 F4	Lo Lo Hi Lo	A112 A112 A136 A112	1 2 1 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL BK R	BR R O G	J22 J23 J3 J24 J25 J26
13	F1 F2 F3 F4	Hi Lo Hi Lo	A136 A112 A136 A112	1 2 2 4	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J3 J22 J4 J23 J25 J26
14	F1 F2 F3 F4	Lo Hi Lo Hi	A112 A136 A112 A136	1 1 3 2	A110 A110 A110 A110 A136 A136	J3 J4 J5 J6 H8 H9	W W W W	BL BL BL BL R	BR R O G	J22 J3 J23 J4 J25 J26





SUB-BAND CONNECTIONS CHART

CONNECTION CHARTS TRANSMITTER MODELS 4ET58J10, 11 & 12

Issue 1

15

ORDERING SERVICE PARTS

Each component appearing on the schematic diagram is identified by a symbol number, to simplify locating it in the parts list. Each component is listed by symbol number, followed by its description and GE Part Number.

Service Parts may be obtained from Authorized GE Communication Equipment Service Stations or through any GE Radio Communication Equipment Sales Office. When ordering a part, be sure to give:

- 1. GE Part Number for component
- 2. Description of part
- 3. Model number of equipment 4. Revision letter stamped on unit

These instructions do not purport to cover all details or variations in equipment nor to provide for every possible contingency to be met in connection with installation, operation or maintenance.

Should further information be desired, or should particular problems arise which are not covered sufficiently for the purchaser's purposes, contact the nearest Radio Communication Equipment Sales Office of the General Electric Company.

LBI-4306

DF-3125

MOBILE RADIO DEPARTMENT
GENERAL ELECTRIC COMPANY • LYNCHBURG, VIRGINIA 24502

